

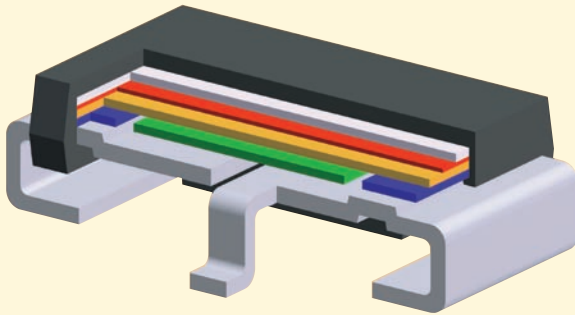
# ISA-PLAN<sup>®</sup> -SMD

## Precision and power resistors

### The mΩ-concept

Precision current measurement in the ampere range with SMD resistors? For many manufacturers and users a problem that was difficult to solve in the past. If the requirements for large pulse currents coincided with high ambient temperatures, this obviously resulted in a contradiction that could only be solved inadequately or not at all using the existing resistance technologies.

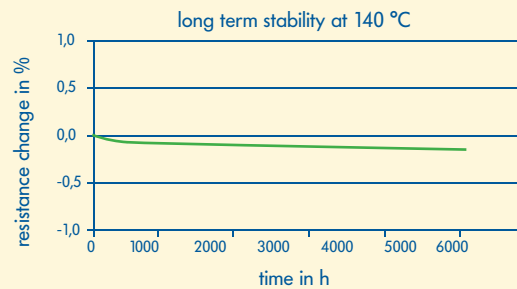
Not so with the ISA-PLAN<sup>®</sup> technology developed by ISABELLENHÜTTE. Here the resistance components are manufactured from etched, bulk MANGANIN<sup>®</sup> foils and, electrically insulated, mounted on a substrate with good thermal conductivity. Today, five established SMD product families are available on the market, which cover nearly all requirements of our customers.



Construction of the SMV resistor

The essential base is the application of the precision resistance alloy MANGANIN<sup>®</sup> with its very low temperature coefficient of 10 ppm/K and the extremely good long-term stability.

In addition, the resistance alloy has thermo-electrically been matched to copper so that the thermal EMF is reduced almost to zero. Despite the relatively high load capacity, the intrinsic temperature rise of the resistance foil is very low due to the high thermal conductivity of the composite material with the consequence that the resistance drift even at rated load and simultaneously high ambient temperatures is only a few tenth of a percent after several 1,000 hours.



Typical long-term behaviour at 140 °C

Optimized current density distribution in the component avoids the danger of hot spots. The relatively high mass of the resistance material and the high thermal capacity of the metal substrate ensure sound pulse capacity.

The ISA-PLAN<sup>®</sup> foil technology is ideally suited for the manufacture of SMD resistors in the value range from 0.1 mOhm to 20 Ohm. The planar construction permits the ideal realization of the 4-terminal connection technology. This is a prerequisite for the manufacture of temperature coefficients of 10 ppm/K and below with great reproducibility even with values <10 mOhm. With the low-inductivity structures, the components are ideally suited for use in switch-mode driven power electronics.



## Conventional SMD assembly

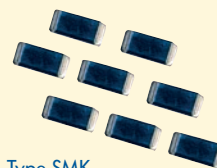
### Technical data

Value ranges	5 mΩ - 2 Ω
Tolerance	0.5, 1, 5 %
TC	< 50 ppm/K
Power	up to 3 Watt
Contin. current	up to 25 A
Pulse energy	up to 0.2 J
Rthi	from 13 K/W

### Versions SMK / SMP / SMS / SMT

#### Description

- Precision and power resistor
- Flat, compact design



Type SMK  
Design 1206

#### Special features

- 4-terminal connection technology on the substrate
- Can be reflow- and wave-soldered
- Low internal thermal resistance



Type SMP  
Design 2010



Type SMS  
Design 2512



Type SMT  
Design 2817

### Technical data

Value ranges	1 mΩ - 4.7 Ω
Tolerance	0.5, 1, 5 %
TC	< 30 ppm/K
Power	up to 3 Watt
Contin. current	up to 50 A
Pulse energy	up to 0.5 J
Rthi	from 15 K/W

### Versions SMR / SMV

#### Description

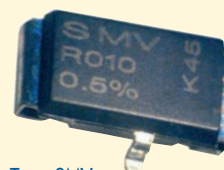
- Precision and power resistor
- In Duroplast package



Type SMR  
Design 4723

#### Special features

- 4-terminal connection technology on the substrate
- Solid Cu contact suitable for high current load
- Can be reflow- and wave-soldered



Type SMV  
Design 4723

### Technical data

Value ranges	1 - 100 mΩ
Tolerance	1*, 5 %
TC	< 50 ppm/K
Power	up to 2 Watt
Contin. current	up to 44 A (1mOhm)
Pulse energy	up to 0.1 J
Rthi	from 25 K/W

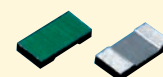
\* under development

### Versions LMK / LMP / LMS

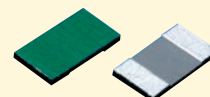
#### Description

- Low ohmic precision and power resistor
- extremely low inductance

Type LMK  
Design 1206



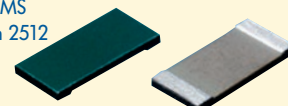
Type LMP  
Design 2010



#### Special features

- standard pad size
- reduced internal heat resistance
- high pulse power

Type LMS  
Design 2512

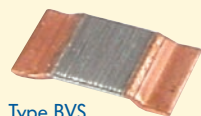


## Flip chip assembly

# Precision and power resistors

## Versions BVR / BVS / BVE

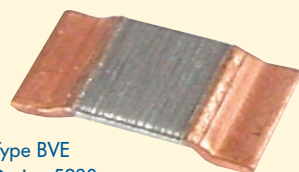
SMD-resistors of composite materials



Type BVS  
Design 3920



Type BVR  
Design 3925



Type BVE  
Design 5930

## Technical data

Value ranges	0.1 - 4 m $\Omega$
Tolerance	1, 5 %
TC	< 50 ppm/K
Power	up to 5 Watt
Contin.current	up to 160 A
Pulse energy	up to 5 J
Rthi	from 4 K/W

## Description

- SMD-precision and power resistor
- Made from electron beam welded composite materials (Copper-MANGANIN<sup>®</sup>-Copper)

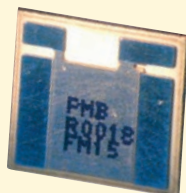
## Special features

- Lowest resistance values
- Welding assembly on Cu punched grid
- Ideal for the assembly on DCB / IMS
- 4-terminal connection for BVR

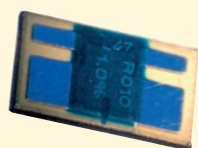
## Versions SMH / PMB / PMU



Type SMH  
Design 2512



Type PMB  
Design 3939



Type PMU  
Design 3925

## Technical data

Value ranges	1m $\Omega$ - 20 $\Omega$
Tolerance	0.5, 1, 5 %
TC	< 30 ppm/K
Power	up to 20 Watt
Contin.current	130 A
Pulse energy	up to 1 J
Rthi	from 2.5 K/W

## Description

- Precision and power resistor
- Bondable voltage and current terminal areas

## Special features

- 4-terminal connection technology
- Direct DCB / IMS solder assembly
- Very high load capacity

Hybrid-assembly

# ISA-PLAN<sup>®</sup> SMD

## Precision and power resistors

### The mΩ-concept

#### Technology

##### ISA-PLAN<sup>®</sup> foil resistors!

- Vacuum lamination technology
- Reproducible precision etching structures
- Ni diffusion barrier layers
- Dip coating of terminals with SnPb
- Bondable contact surfaces

#### Quality

##### Reliability through 100 % inspection!

- Manufacture according to TS16949
- Clear traceability through continuous documentation
- Full labeling including date code

#### Solderability

##### Processability in all known soldering processes!

- Hot air, reflow, IR and wave soldering process
- Hybrid resistors can be processed at 250 °C (10 min)
- Bond pads treated according to specification

#### Specification

##### Application-oriented support!

- Internal qualification of components according to MIL 202
- Simulation of your operating conditions
- Component optimization for critical applications especially in automotive market
- SMD test boards for pilot tests
- Comprehensive documentation

#### Value range

##### Standard values available ex stock at short notice!

- E6/ E12/ decade values depending on version
- Intermediate values on request
- 24 hour component dispatch

#### Packaging

##### Delivery in standard SMD packages!

- Long shelf life / sound processability through dip coated surfaces
- Packaged under inert gas in carrier tape
- Types according to IEC 286-3 (EIA-481)
- Hybrid SMD available as an alternative in chip tray

#### Support

##### User information on the SMD-hotline!

- Dr. Ullrich Hetzler - 240 Manager R & D
- Thomas Otto - 282 Technical Sales

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ISABELLENHÜTTE

ISABELLENHÜTTE Heusler GmbH KG  
Eibacher Weg 3-5 · 35683 Dillenburg  
P.O. Box 1453 · D-35664 Dillenburg

Phone +49 2771/ 934-0 · Facsimile +49 2771/ 23030  
[www.isabellenuette.de](http://www.isabellenuette.de) · [www.isa-asic.de](http://www.isa-asic.de)  
[vk.bauelemente@isabellenuette.de](mailto:vk.bauelemente@isabellenuette.de)